









































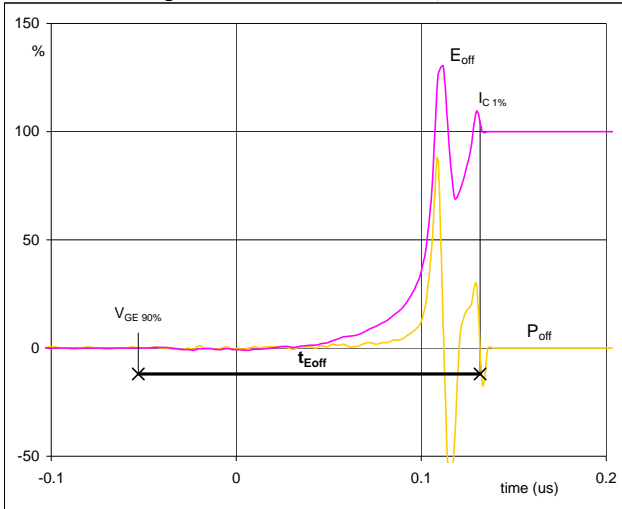






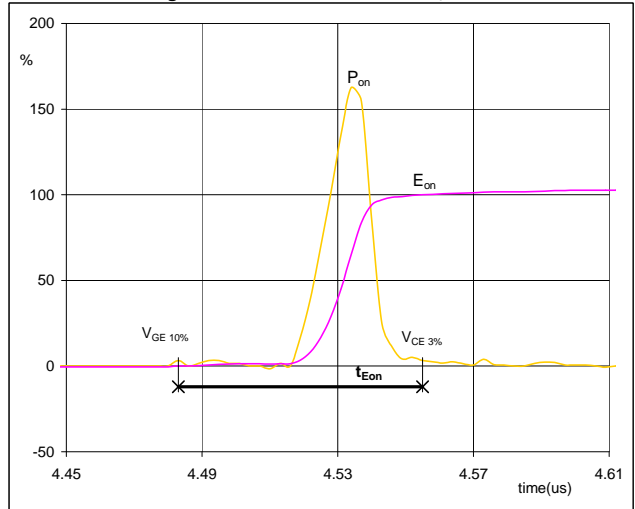
## Switching Definitions H-Bridge MOSFET

**Figure 5** H-Bridge MOSFET

**Turn-off Switching Waveforms & definition of  $t_{Eoff}$** 


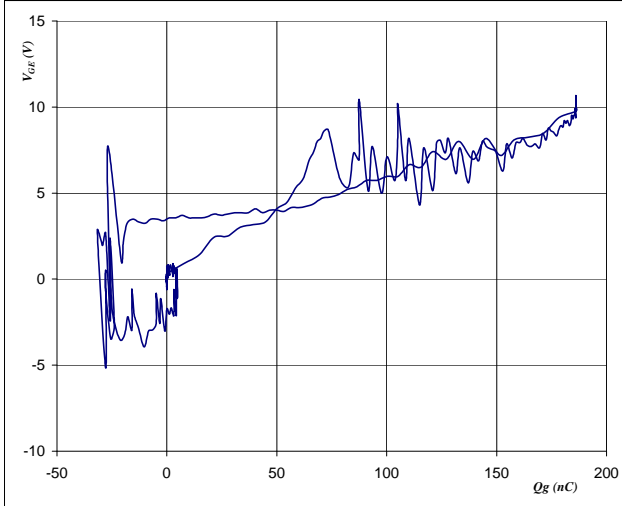
$P_{off}(100\%) = 12.15 \text{ kW}$   
 $E_{off}(100\%) = 0.05 \text{ mJ}$   
 $t_{Eoff} = 0.18 \text{ }\mu\text{s}$

**Figure 6** H-Bridge MOSFET

**Turn-on Switching Waveforms & definition of  $t_{Eon}$** 


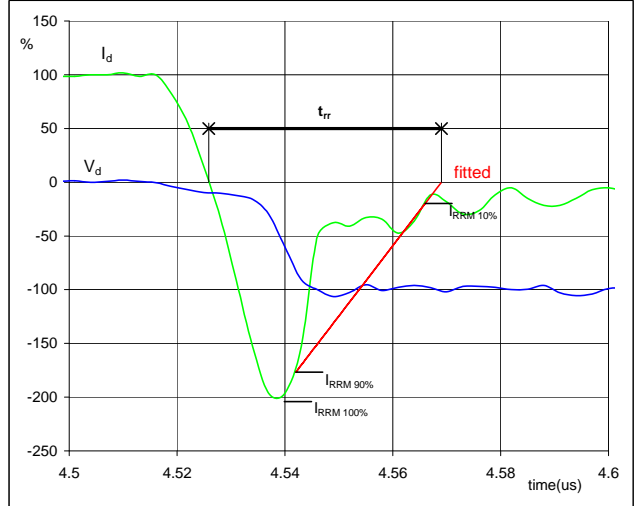
$P_{on}(100\%) = 12.15 \text{ kW}$   
 $E_{on}(100\%) = 0.31 \text{ mJ}$   
 $t_{Eon} = 0.07 \text{ }\mu\text{s}$

**Figure 7** H-Bridge MOSFET

**Gate voltage vs Gate charge (measured)**


$V_{GEoff} = 0 \text{ V}$   
 $V_{GEon} = 10 \text{ V}$   
 $V_C(100\%) = 400 \text{ V}$   
 $I_C(100\%) = 30 \text{ A}$   
 $Q_g = 186.04 \text{ nC}$

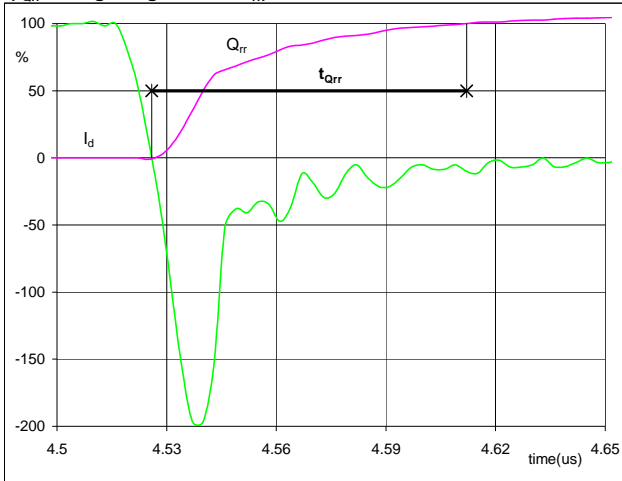
**Figure 8** H-Bridge FWD

**Turn-off Switching Waveforms & definition of  $t_{rr}$** 


$V_d(100\%) = 400 \text{ V}$   
 $I_d(100\%) = 30 \text{ A}$   
 $I_{RRM}(100\%) = -61 \text{ A}$   
 $t_{rr} = 0.04 \text{ }\mu\text{s}$

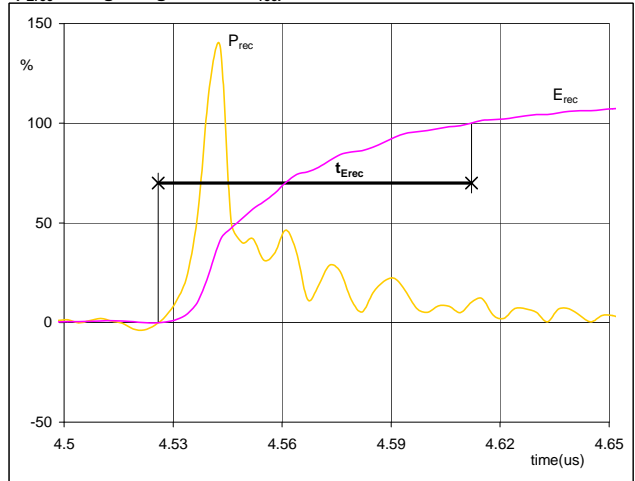
## Switching Definitions H-Bridge MOSFET

**Figure 9** H-Bridge FWD

**Turn-on Switching Waveforms & definition of  $t_{Qrr}$**   
 ( $t_{Qrr}$  = integrating time for  $Q_{rr}$ )


$I_d$ (100%) =	30	A
$Q_{rr}$ (100%) =	1.29	$\mu\text{C}$
$t_{Qrr}$ =	0.09	$\mu\text{s}$

**Figure 10** H-Bridge FWD

**Turn-on Switching Waveforms & definition of  $t_{Erec}$**   
 ( $t_{Erec}$  = integrating time for  $E_{rec}$ )


$P_{rec}$ (100%) =	12.15	kW
$E_{rec}$ (100%) =	0.35	mJ
$t_{Erec}$ =	0.09	$\mu\text{s}$

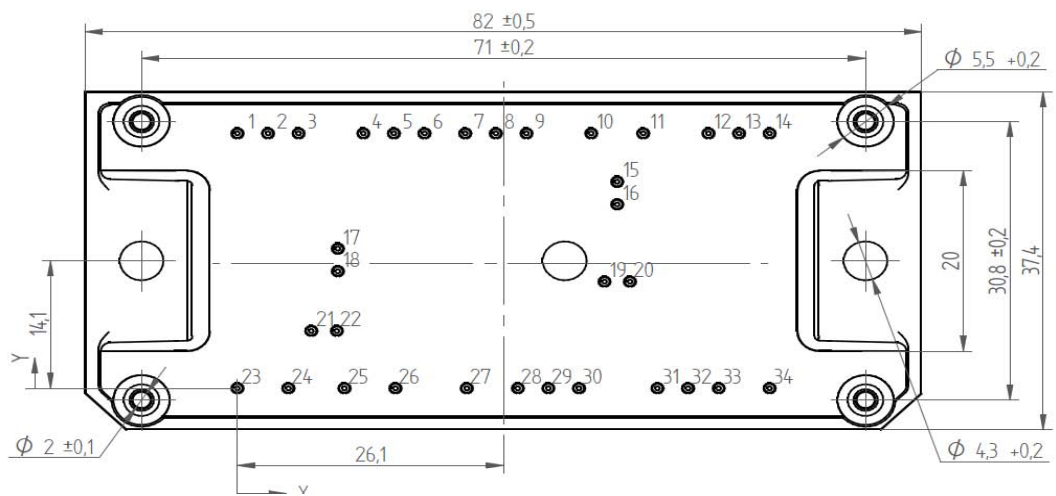
### Ordering Code and Marking - Outline - Pinout

#### Ordering Code & Marking

Version	Ordering Code	in DataMatrix as	in packaging barcode as
without thermal paste 12mm housing	10-FY07BIA041MF-M528E68	M528E68	M528E68

#### Outline

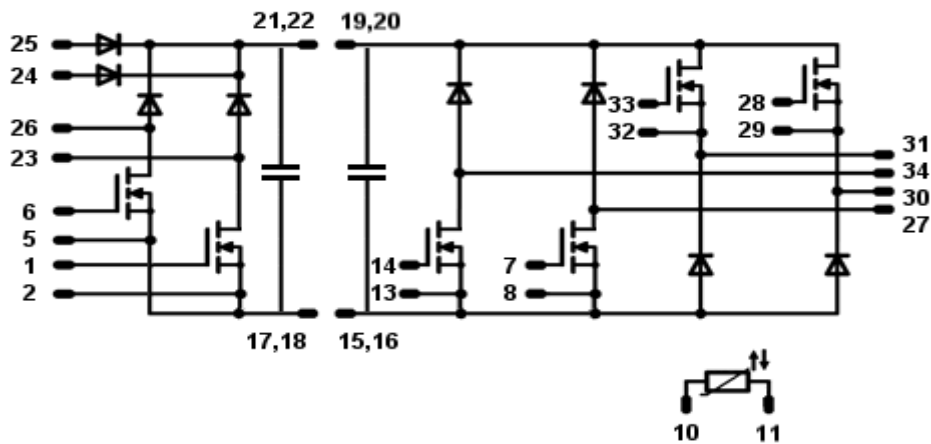
Pin table		
Pin	X	Y
1	0	28.2
2	3	28.2
3	6	28.2
4	12.35	28.2
5	15.35	28.2
6	18.35	28.2
7	22.35	28.2
8	25.35	28.2
9	28.35	28.2
10	34.7	28.2
11	39.8	28.2
12	44.2	28.2
13	49.2	28.2
14	52.2	28.2
15	37.25	22.85
16	37.25	20.35
17	9.85	15.45
18	9.85	12.95
19	36	11.8
20	38.5	11.8
21	7.25	6.35
22	9.75	6.35
23	0	0
24	5	0
25	10.5	0
26	15.5	0
27	22.5	0
28	27.5	0
29	30.5	0
30	33.5	0



Pin table		
Pin	X	Y
31	41.2	0
32	44.2	0
33	47.2	0
34	52.2	0

Tolerance of pinpositions:  $\pm 0.5\text{mm}$  at the end of pins  
Dimension of coordinate axis is only offset without tolerance  
PCB cutouts and holes see in handling instructions document

#### Pinout



Pins 3,4,9,12 are not connected.



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Datasheet Status	Product Status	Definition
Target	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. The data contained is exclusively intended for technically trained staff.
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Final	Full Production	This datasheet contains final specifications. Vincotech reserves the right to make changes at any time without notice in order to improve design. The data contained is exclusively intended for technically trained staff.

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.